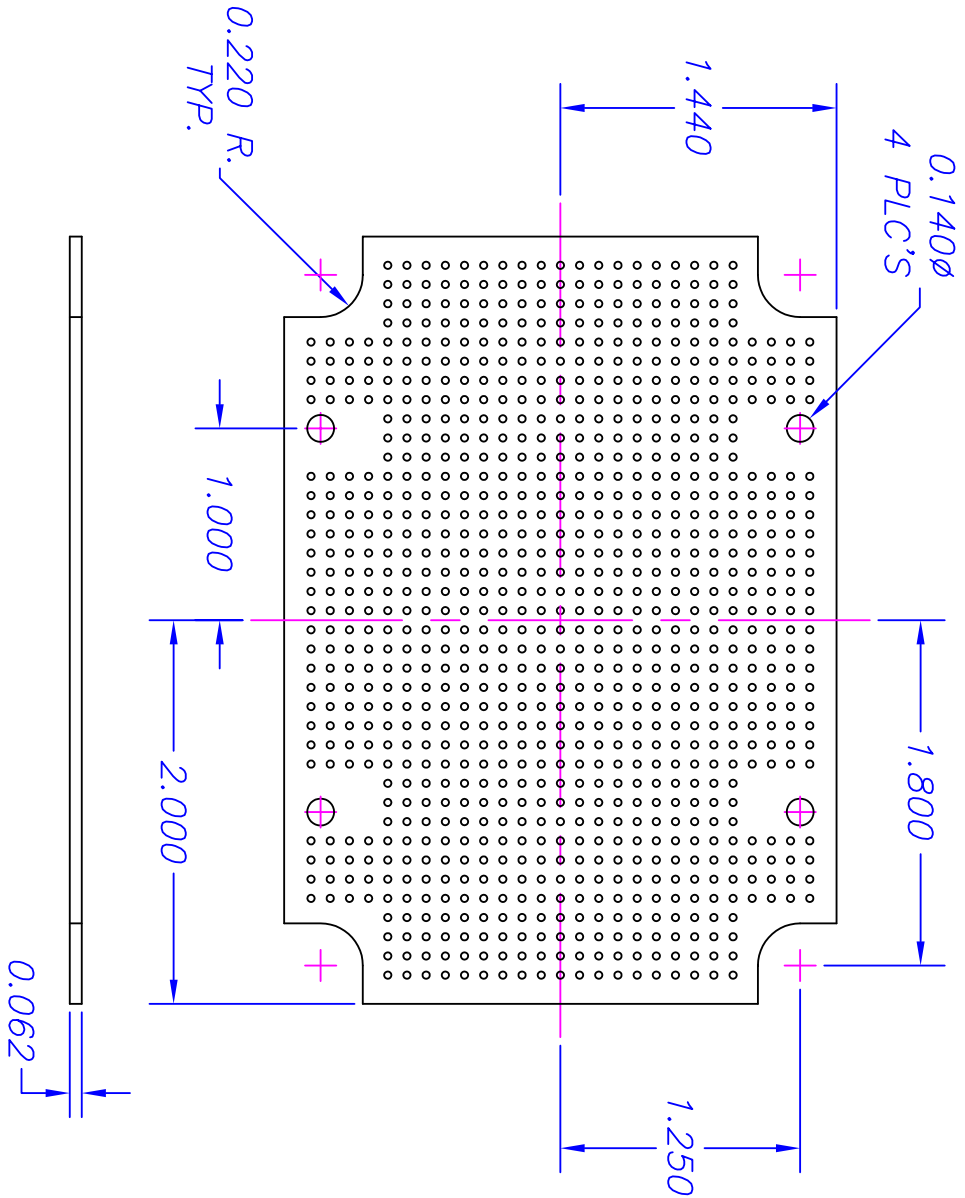


**SERPAC** **CIRCUIT BOARD 330/430**  
Electronics Enclosures



**NOTES:**

1. GRID BOARD: 0.038Ø HOLES, 0.100 CENTER TO CENTER SPACING
2. MATERIAL: G-10 GLASS EPOXY (p/n 3XX)
3. MATERIAL: CLAD BOARD-2 OZ., 2/0 COPPER FOIL (p/n 4XX) -No Holes.

04-2002.

ALL DIMENSIONS ±.005

NO.	REVISION	DATE
A	Update dwg G & C in 1 dwg.	4/02